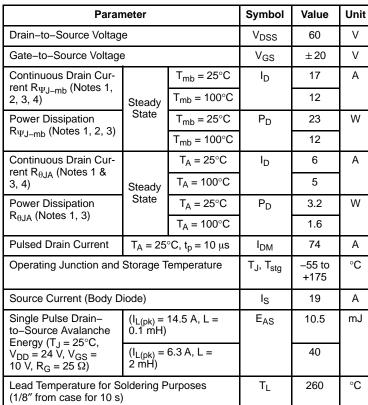
## **Power MOSFET** 60 V, 39 mΩ, 17 A, Dual N–Channel, Logic Level, Dual SO8FL

#### Features

- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- NVMFD5877NLWF Wettable Flanks Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant

#### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)



Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE MAXIMUM RATINGS (Note 1)

Parameter	Symbol	Value	Unit	
Junction-to-Mounting Board (top) - Steady State (Note 2, 3)	$R_{\PsiJ-mb}$	6.5	°C/W	
Junction-to-Ambient - Steady State (Note 3)	$R_{\thetaJA}$	47		

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

 Psi (Ψ) is used as required per JESD51–12 for packages in which substantially less than 100% of the heat flows to single case surface.
Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.

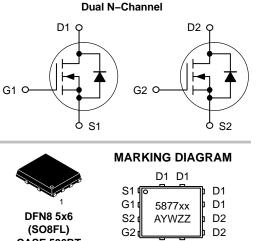
 Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



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V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> MAX	I <sub>D</sub> MAX
60 V	39 mΩ @ 10 V	17 A
00 V	60 mΩ @ 4.5 V	



CASE 506BT	D2 D2
5877NL	= Specific Device Code for NVMFD5877NL
5877LW	= Specific Device Code for NVMFD5877NLWF
А	= Assembly Location
Y	= Year
W	= Work Week
ZZ	= Lot Traceability

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>		
NVMFD5877NLT1G	DFN8 (Pb–Free)	1500 / Tape & Reel		
NVMFD5877NLWFT1G	DFN8 (Pb-Free)	1500 / Tape & Reel		
NVMFD5877NLT3G	DFN8 (Pb-Free)	5000 / Tape & Reel		
NVMFD5877NLWFT3G	DFN8 (Pb–Free)	5000 / Tape & Reel		

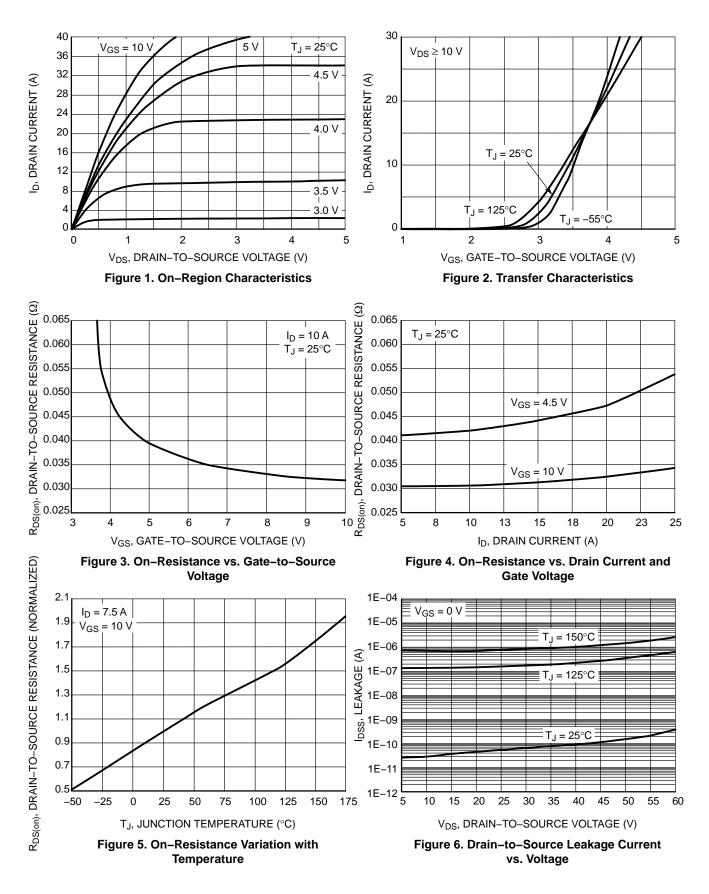
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise specified)

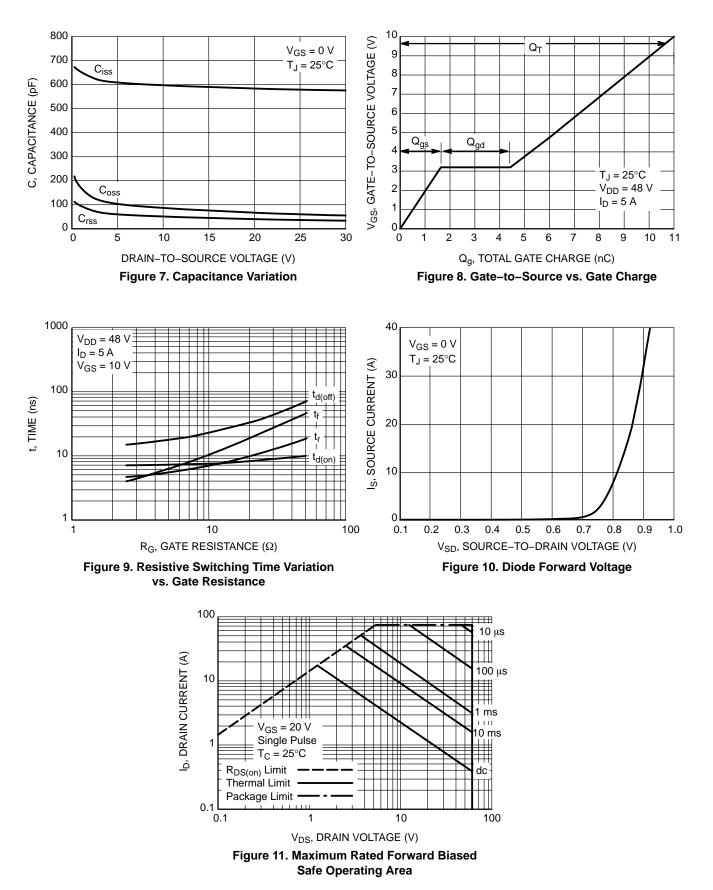
Parameter	Symbol	Test Cond	ition	Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA		60	l	1	V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /T <sub>J</sub>				53		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V,	$T_J = 25^{\circ}C$			1.0	μΑ
		$V_{DS} = 60 V$	$T_J = 125^{\circ}C$			10	1
Gate-to-Source Leakage Current	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS}$	= ±20 V			±100	nA
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_{D}$	= 250 μA	1.0		3.0	V
Negative Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				3.5		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 7.5 A		31	39	mΩ
		V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 7.5 A		42	60	-
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub>	= 5.0 A		7.0	1	S
CHARGES AND CAPACITANCES	-				•		
Input Capacitance	C <sub>iss</sub>				540		pF
Output Capacitance	C <sub>oss</sub>	$V_{GS}$ = 0 V, f = 1.0 MHz, $V_{DS}$ = 25 V			55		-
Reverse Transfer Capacitance	C <sub>rss</sub>				36		-
Total Gate Charge	Q <sub>G(TOT)</sub>				5.9		nC
Threshold Gate Charge	Q <sub>G(TH)</sub>	V <sub>GS</sub> = 4.5 V, V <sub>D</sub>	s = 48 V.		0.62		-
Gate-to-Source Charge	Q <sub>GS</sub>	$I_{\rm D} = 5.0$			1.64		
Gate-to-Drain Charge	Q <sub>GD</sub>				2.80		1
Total Gate Charge	Q <sub>G(TOT)</sub>	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 4	8V, I <sub>D</sub> = 5.0A		11	20	nC
SWITCHING CHARACTERISTICS (No							
Turn–On Delay Time	t <sub>d(on)</sub>				8.1	1	ns
Rise Time	t <sub>r</sub>	$V_{CC} = 4.5 V_{\rm v} V_{\rm D}$	$c = 48 V_{c}$		15.8		-
Turn–Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ = 4.5 V, $V_{D}$ $I_{D}$ = 5.0 A, $R_{G}$	= 2.5 Ω		11.8		-
Fall Time	t <sub>f</sub>				3.9		-
Turn–On Delay Time	t <sub>d(on)</sub>				4.9		ns
Rise Time	t <sub>r</sub>	V <sub>GS</sub> = 10 V, V <sub>D</sub>	s = 48 V.		6.4		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_{\rm D} = 5.0  \rm A,  R_{\rm G}$			14.5		-
Fall Time	t <sub>f</sub>	1			2.4		
DRAIN-SOURCE DIODE CHARACTE	ERISTICS						•
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V,	T <sub>J</sub> = 25°C		0.8	1.2	V
-	02	$I_{\rm S} = 5.0 \rm{A}$	T <sub>J</sub> = 125°C		0.7		-
Reverse Recovery Time	t <sub>RR</sub>				14.5		ns
Charge Time	t <sub>a</sub>	$V_{GS}$ = 0 V, $d_{IS}/d_{t}$ = 100 A/µs, I <sub>S</sub> = 5.0 A			11.5		-
Discharge Time	t <sub>b</sub>				3.1		-
Reverse Recovery Charge	Q <sub>RR</sub>				11	İ	nC
PACKAGE PARASITIC VALUES	-				•		-
Source Inductance	Ls	- T <sub>A</sub> = 25°C			0.93		nH
Drain Inductance	L <sub>D</sub>				0.005		
Gate Inductance	L <sub>G</sub>				1.84		1
Gate Resistance	R <sub>G</sub>				1.5		Ω

5. Pulse Test: pulse width = 300  $\mu$ s, duty cycle  $\leq 2\%$ . 6. Switching characteristics are independent of operating junction temperatures.

#### **TYPICAL CHARACTERISTICS**



#### **TYPICAL CHARACTERISTICS**



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#### **TYPICAL CHARACTERISTICS**

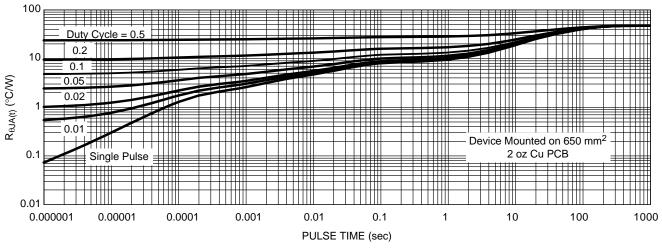
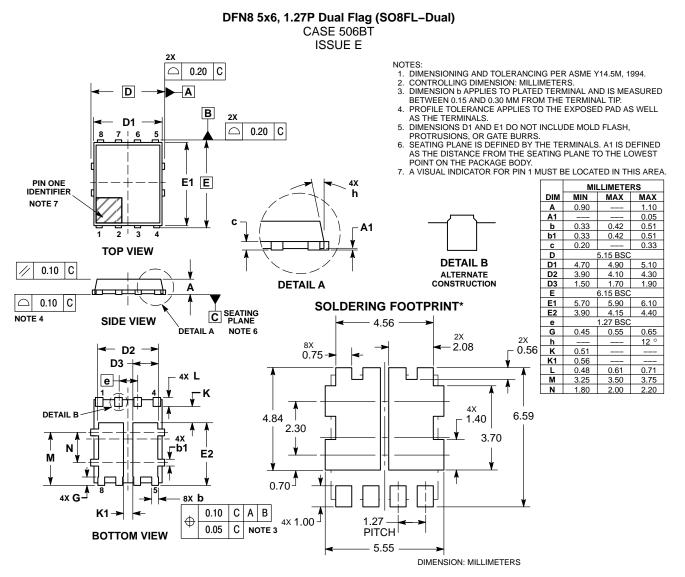


Figure 12. Thermal Response

#### PACKAGE DIMENSIONS



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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